

SAW duplexer Small cell & femtocell LTE band 8

Series/type: B8048

Ordering code: B39941B8048P810

Date: July 06, 2017

Version: 2.5

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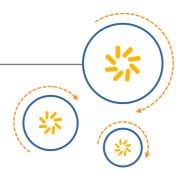
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RF360 Europe GmbH
A Qualcomm – TDK Joint Venture



SAW components

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SAW duplexer 897.5 / 942.5 MHz

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1 Application

- Low-loss SAW duplexer for 3G/LTE small cell and femtocell systems (Band 8)
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 35 MHz
- High isolation between Tx and Rx
- Rx = uplink = 880-915 MHz
- \blacksquare Tx = downlink = 925-960 MHz
- Industrial qualification

2 Features

- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.5 mm (max.)
- Approximate weight 0.01 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)

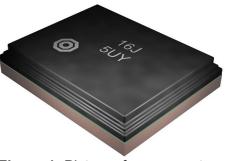
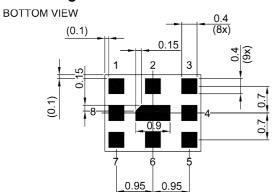


Figure 1: Picture of component with example of product marking.

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3 Package



4 Pin configuration

1 TX

13 RX

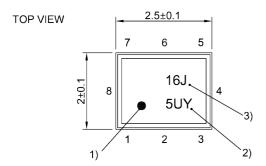
■ 6 ANT

■ 2, 4, 5, 7, Ground 8, 9

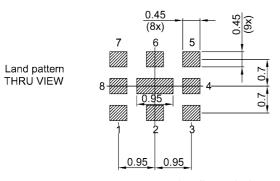
Pad and pitch tolerance ±0.05

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 28).



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5 Matching circuit

■ L_{p6} = 8.2 nH

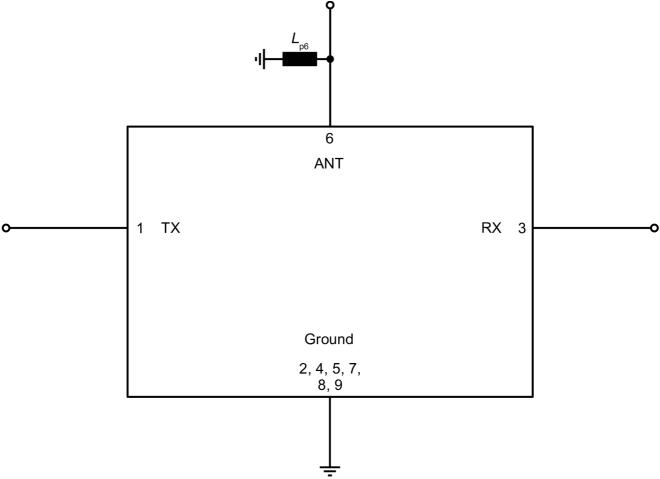


Figure 3: Schematic of matching circuit.



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= -10 °C ... +85 °C

= 50Ω

 $T_{\rm SPEC}^{-1)}$

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6 Characteristics

6.1 TX - ANT

Temperature range for specification

TX terminating impedance

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 8.2 nH²

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics TX – ANT				$\begin{array}{c} \textbf{min.} \\ \textbf{for } T_{\texttt{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	942.5	_	MHz
Maximum insertion attenuation							
	925 930	MHz	$\alpha_{\text{INT,max}}^{ 3)}$	_	1.5	2.4	dB
	925.24 959.76	MHz	$\boldsymbol{\alpha}_{\text{max}}$	_	1.9	3.0	dB
	930 955	MHz	$\alpha_{_{INT,max}}^{3)}$	_	1.1	2.1	dB
	955 960	MHz	$\alpha_{\text{INT,max}}^{3)}$	_	1.2	2.4	dB
Amplitude ripple (p-p)			Δα				
	925.24 959.76	MHz		_	1.2	2.04)	dB
	925.24 959.76	MHz		_	1.2	2.2	dB
Maximum group delay			$ au_{max}$				
	925.24 959.76	MHz		_	70	110	ns
Maximum VSWR			$VSWR_{max}$				
@ TX port	925.24 959.76	MHz		_	1.7	2.1	
@ ANT port	925.24 959.76	MHz		_	1.7	2.1	
Maximum error vector magnitude			$EVM_{max}^{}5)}$				
	927.4 957.6	MHz		_	2.7	5.3	%
Minimum attenuation			$\boldsymbol{\alpha}_{_{min}}$				
	10 791	MHz		30	38	_	dB
	791 821	MHz		35	39	_	dB
	832 862	MHz		35	41	_	dB
	880.24 914.76	MHz		45	53	_	dB
	1570 1606	MHz		30	52	_	dB
	1710 1785	MHz		35	52	_	dB
	1805 1880	MHz		35	56	_	dB
	1920 1980	MHz		35	54	_	dB
	2110 2170	MHz		35	50	_	dB
	2400 2500	MHz		35	48	_	dB
	2500 2570	MHz		35	49	_	dB
	2620 2690	MHz		35	48	_	dB
	3400 3800	MHz		30	39	_	dB
	3800 5850	MHz		20	35	_	dB



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Group delay ripple			$\Delta \tau_{\text{var}}$				
	925.24 959.76	MHz		_	45	90	ns

¹⁾ T is the ambient temperature of the PCB at component position.

²⁾ See Sec. Matching circuit (p. 6).

Integrated attenuation $\alpha_{|NT|}$: Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

Valid for temperature T = 0 °C...+85 °C.

⁵⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



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= -40 °C ... +95 °C Temperature range for specification

 Z_{TX} Z_{ANT} = 50 Ω TX terminating impedance

ANT terminating impedance = 50 Ω with par. 8.2 nH¹⁾

RX terminating impedance $= 50 \Omega$

Characteristics TX – ANT				$\begin{array}{c} \textbf{min.} \\ \textbf{for } T_{\texttt{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Maximum insertion attenuation				SFEC		SFEC	
	925 930	MHz	$\alpha_{\text{INT,max}}^{\qquad 2)}$	_	1.5	3.0	dB
	925.24 959.76	MHz	α_{max}	_	1.9	3.8	dB
	930 955	MHz	$\alpha_{\text{INT,max}}^{\qquad 2)}$		1.1	2.1	dB
	955 960	MHz	$\alpha_{\text{INT,max}}^{2)}$	_	1.2	3.0	dB
Amplitude ripple (p-p)			Δα				
	925.24 959.76	MHz		_	1.2	3.1	dB
Maximum group delay			$\boldsymbol{\tau}_{\text{max}}$				
	925.24 959.76	MHz		_	70	150	ns
Maximum VSWR			VSWR _{max}				
@ TX port	925.24 959.76	MHz		_	1.7	2.5	
@ ANT port	925.24 959.76	MHz		_	1.7	2.5	
Maximum error vector magnitude			EVM _{max} ³⁾				
	927.4 957.6	MHz		_	2.7	7.9	%
Minimum attenuation			$\boldsymbol{\alpha}_{_{min}}$				
	10 791	MHz		30	38	_	dB
	791 821	MHz		35	39	_	dB
	832 862	MHz		35	41	_	dB
	880.24 914.76	MHz		41	53	_	dB
	1570 1606	MHz		30	52	_	dB
	1710 1785	MHz		35	52	_	dB
	1805 1880	MHz		35	56	_	dB
	1920 1980	MHz		35	54	_	dB
	2110 2170	MHz		35	50	_	dB
	2400 2500	MHz		35	48	_	dB
	2500 2570	MHz		35	49	_	dB
	2620 2690	MHz		35	48	_	dB
	3400 3800	MHz		30	39	_	dB
	3800 5850	MHz		20	35	_	dB
Group delay ripple			$\Delta \tau_{\text{var}}$				
	925.24 959.76	MHz		_	45	130	ns

See Sec. Matching circuit (p. 6).

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



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³⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



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6.2 ANT - RX

Temperature range for specification $T_{\text{SPEC}}^{(1)} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TV} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 8.2 nH²

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	897.5	_	MHz
Maximum insertion attenuation							
	880 885	MHz	$\alpha_{\text{INT,max}}^{ 3)}$	_	1.3	2.4	dB
	880.24 914.76	MHz	$\boldsymbol{\alpha}_{\text{max}}$	_	1.6	3.0	dB
	885 910	MHz	$\alpha_{\text{INT,max}}^{ 3)}$	_	1.1	2.1	dB
	910 915	MHz	$\alpha_{\text{INT,max}}^{ 3)}$	_	1.3	2.4	dB
Amplitude ripple (p-p)			Δα				
	880.24 914.76	MHz		_	0.8	2.0	dB
Maximum group delay			$\boldsymbol{\tau}_{\text{max}}$				
	880.24 914.76	MHz		_	70	140	ns
Maximum VSWR			$VSWR_{max}$				
@ ANT port	880.24 914.76	MHz		_	1.7	2.1	
@ RX port	880.24 914.76	MHz		_	1.7	2.1	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 791	MHz		30	39	_	dB
	791 821	MHz		35	41	_	dB
	832 862	MHz		35	48	_	dB
	925.24 959.76	MHz		45	53	_	dB
	1710 1785	MHz		30	54	_	dB
	1805 1880	MHz		35	54	_	dB
	1920 1980	MHz		30	49	_	dB
	2110 2170	MHz		30	47	_	dB
	2400 2500	MHz		35	46	_	dB
	2500 2570	MHz		35	46	_	dB
	2620 2690	MHz		30	45	_	dB
	2690 3800	MHz		25	37	_	dB
	3800 5850	MHz		18	27	_	dB
Group delay ripple			$\Delta \tau_{\text{var}}$				
	880.24 914.76	MHz		_	45	120	ns

¹⁾ T is the ambient temperature of the PCB at component position.

²⁾ See Sec. Matching circuit (p. 6).

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



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= -40 °C ... +95 °C Temperature range for specification

 Z_{TX} Z_{ANT} = 50 Ω TX terminating impedance

ANT terminating impedance = 50 Ω with par. 8.2 nH¹⁾

RX terminating impedance $= 50 \Omega$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Maximum insertion attenuation				SFEC		SPEC	
	880 885	MHz	$\alpha_{\text{INT,max}}^{\qquad 2)}$	_	1.3	3.0	dB
	880.24 914.76	MHz	$\alpha_{\sf max}$	_	1.6	4.6	dB
	885 910	MHz	$\alpha_{_{INT,max}}^{\qquad 2)}$	_	1.1	2.1	dB
	910 915	MHz	α _{INT,max} ²⁾	_	1.3	3.0	dB
Amplitude ripple (p-p)			Δα				
	880.24 914.76	MHz		_	0.8	3.6	dB
Maximum group delay			$\boldsymbol{\tau}_{\text{max}}$				
	880.24 914.76	MHz		_	70	160	ns
Maximum VSWR			$VSWR_{max}$				
@ ANT port	880.24 914.76	MHz		_	1.7	2.5	
@ RX port	880.24 914.76	MHz		_	1.7	3.3	
Minimum attenuation			α_{min}				
	10 791	MHz		30	39	_	dB
	791 821	MHz		35	41	_	dB
	832 862	MHz		35	48	_	dB
	925.24 959.76	MHz		38	53	_	dB
	1710 1785	MHz		30	54	_	dB
	1805 1880	MHz		35	54	_	dB
	1920 1980	MHz		30	49	_	dB
	2110 2170	MHz		30	47	_	dB
	2400 2500	MHz		35	46	_	dB
	2500 2570	MHz		35	46	_	dB
	2620 2690	MHz		30	45	_	dB
	2690 3800	MHz		25	37	_	dB
	3800 5850	MHz		18	27	_	dB
Group delay ripple			$\Delta \tau_{\text{var}}$				
	880.24 914.76	MHz		_	45	140	ns

See Sec. Matching circuit (p. 6).

Integrated attenuation α_{INT} : Averaged power $|S_{\parallel}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



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6.3 TX - RX

Temperature range for specification $T_{\text{SPEC}}^{(1)} = -10 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TV} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 8.2 nH²

RX terminating impedance $Z_{\text{RX}} = 50 \,\Omega$

Characteristics TX – RX				min.	typ.	max.	
				for T_{SPEC}	@ +25 °C	for T_{SPEC}	
Minimum isolation							
	880.24 914.76	MHz	$\boldsymbol{\alpha}_{\text{min}}$	50	54	_	dB
	880.24 914.76	MHz	$\alpha_{\text{INT,min}}^{ 3)}$	50	54	_	dB
	925.24 959.76	MHz	$\boldsymbol{\alpha}_{min}$	50	55	_	dB
	925.24 959.76	MHz	$\alpha_{\text{INT,min}}^{ 3)}$	50	55	_	dB

T is the ambient temperature of the PCB at component position.

²⁾ See Sec. Matching circuit (p. 6).

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



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= -40 °C ... +95 °C Temperature range for specification

TX terminating impedance = 50 Ω

Z_{ANT} ANT terminating impedance = 50 Ω with par. 8.2 nH¹⁾

RX terminating impedance $= 50 \Omega$

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Minimum isolation							
	880.24 914.76	MHz	$\boldsymbol{\alpha}_{\text{min}}$	46	54	_	dB
	880.24 914.76	MHz	$\alpha_{\text{INT,min}}^{\qquad 2)}$	48	54	_	dB
	925.24 959.76	MHz	$\alpha_{_{min}}$	42	55	_	dB
	925.24 959.76	MHz	$\alpha_{\text{INT,min}}^{\qquad 2)}$	43	55	_	dB

See Sec. Matching circuit (p. 6).

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



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7 **Maximum ratings**

Operable temperature	T _{OP} = -40 °C +95 °C	
Storage temperature	T _{STG} ¹⁾ = −40 °C +95 °C	
DC voltage	$ V_{DC} ^{2)} = 0 \text{ V}$	
ESD voltage		
	V _{ESD} ³⁾ = 175 V	Machine model.
	V _{ESD} ⁴⁾ = 250 V	Human body model.
Input power @ TX port: 925.24 959.76 MHz	$P_{IN}^{5)} = 28 \text{dBm}$	P _{IN} 28 dBm average - 39 dBm peak LTE 5 MHz downlink for 100000 h @ 55 °C. Source and load impedance 50 Ω.
Operating lifetime with output power at antenna 925.24 959.76 MHz	P _{OUT} ⁶⁾ = 24 dBm	Continuous wave for 100000 h @ 55 °C. Source and load impedance 50 Ω.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

²⁾ In case of applied DC voltage blocking capacitors are mandatory.

³⁾

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

Time to failure (TTF) according to accelerated power durability test and wear out models. Specified min./max. values from section 6 "Characteristics" are valid for maximum power up to 24 dBm.

According to accelerated high temperature operating life (HTOL) test.



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8 Transmission coefficients

8.1 TX - ANT 0.0 α/dB 1.0 —Q 1.130 2.0 1/840 3.0 4.0 920 950 960 970 930 940 *f*/MHz 0.0 20.0 40.0 60.0 80.0 800 850 950 900 1000 1050 1100 *f/*MHz 0.0 20.0 40.0 60.0 80.0

Figure 4: Attenuation TX – ANT.

1000

2000

3000

4000

6000

5000

f/MHz-



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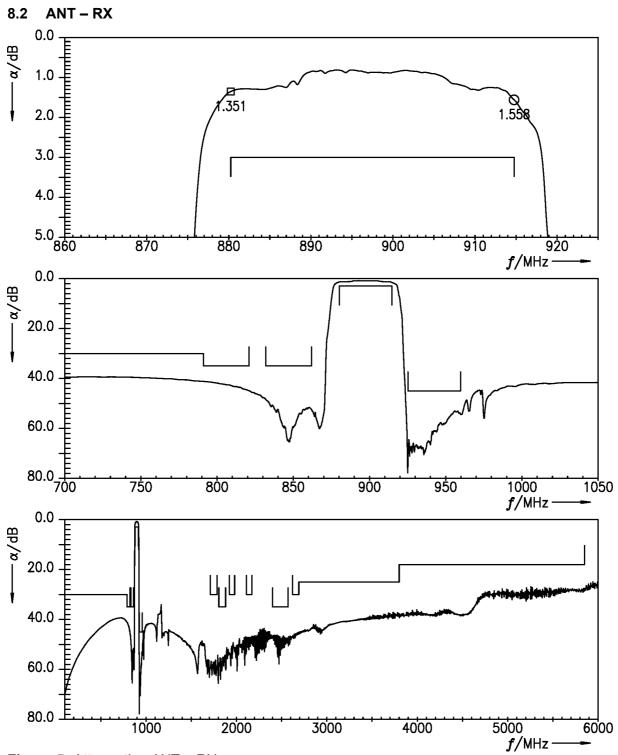


Figure 5: Attenuation ANT – RX.



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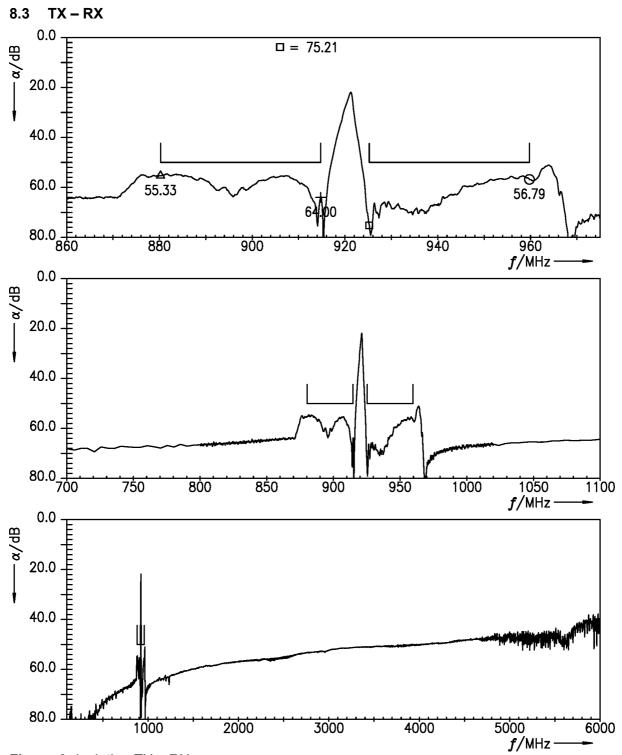


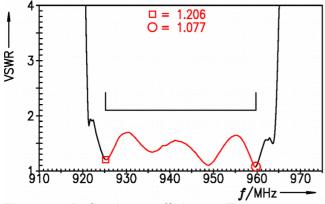
Figure 6: Isolation TX – RX.



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9 Reflection coefficients



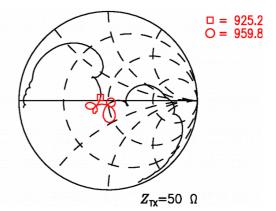
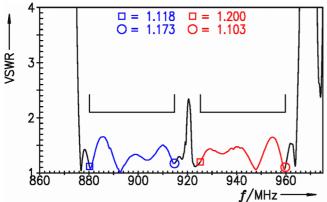


Figure 7: Reflection coefficient at TX port.



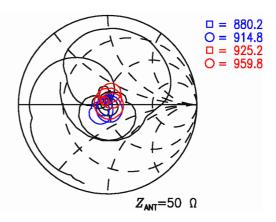
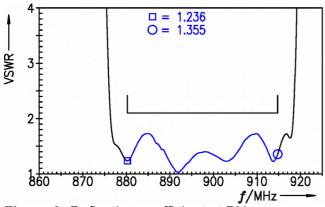


Figure 8: Reflection coefficient at ANT port.



 $\Box = 880.2$ $\bigcirc = 914.8$ $Z_{RX} = 50 \Omega$

Figure 9: Reflection coefficient at RX port.





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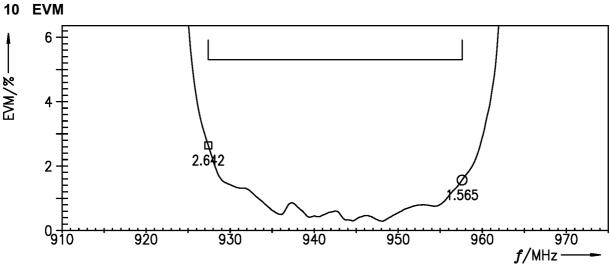


Figure 10: Error vector magnitude.

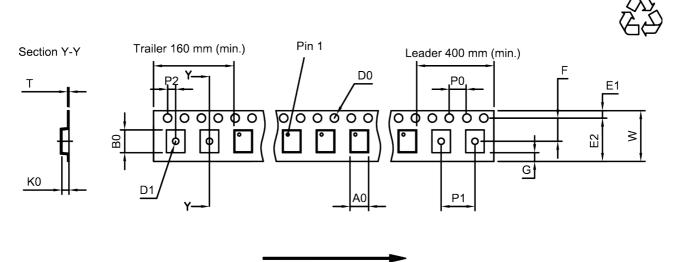


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11 Packing material

11.1 Tape



User direction of unreeling

Figure 11: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	2.25±0.05 mm	_	E_2	6.25 mm (min.)	 P_1	4.0 _{±0.1} mm
B ₀	2.75±0.05 mm		F	3.5±0.05 mm	P_2	2.0±0.05 mm
D_0	1.5+0.1/-0 mm		G	0.75 mm (min.)	Т	0.25±0.03 mm
D ₁	1.0 mm (min.)		K ₀	0.6±0.05 mm	W	8.0+0.3/-0.1 mm
E ₁	1.75 _{±0.1} mm		P ₀	4.0 _{±0.1} mm		

Table 1: Tape dimensions.



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11.2 Reel with diameter of 180 mm

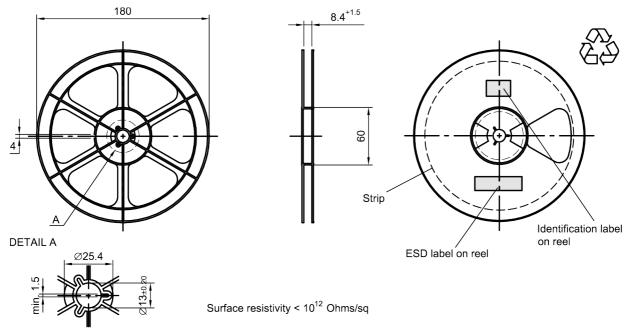


Figure 12: Drawing of reel (first-angle projection) with diameter of 180 mm.

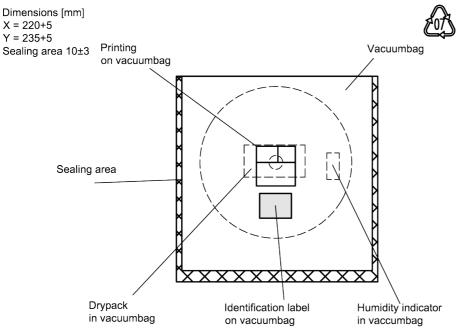


Figure 13: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.



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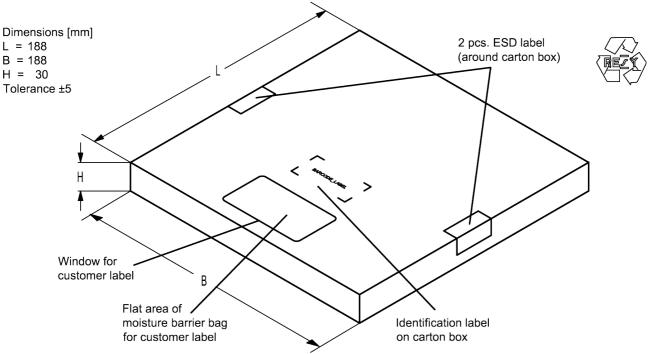


Figure 14: Drawing of folding box for reel with diameter of 180 mm.

11.3 Reel with diameter of 330 mm

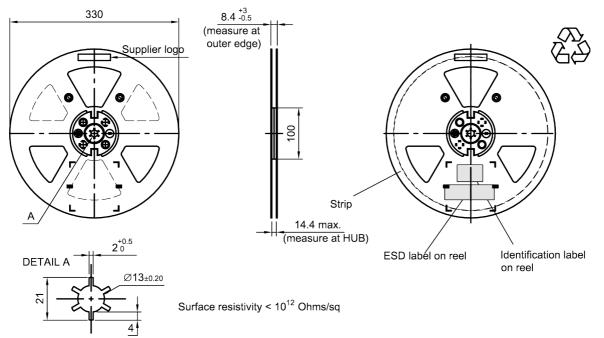


Figure 15: Drawing of reel (first-angle projection) with diameter of 330 mm.



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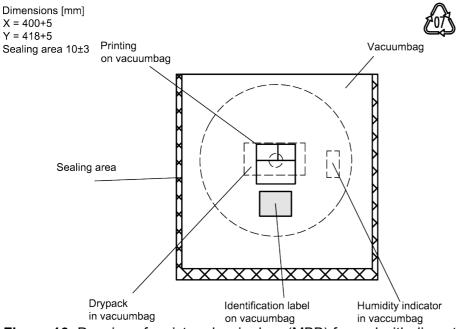


Figure 16: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

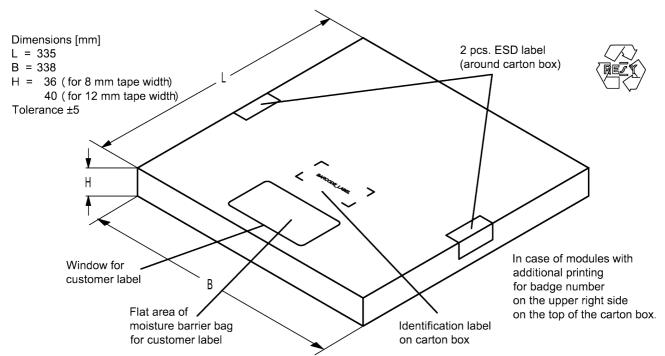


Figure 17: Drawing of folding box for reel with diameter of 330 mm.



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12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B8048 is 7VG.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$ 12345

Adopted BASE32 code for type number									
Decimal	Base32	Decimal	Base32						
value	code	value	code						
0	0	16	G						
1	1	17	Н						
2	2	18	J						
3	3	19	K						
4	4	20	M						
5	5	21	N						
6	6	22	Р						
7	7	23	Q						
8	8	24	R						
9	9	25	S						
10	Α	26	Т						
11	В	27	V						
12	С	28	W						
13	D	29	Х						
14	E	30	Y						
15	F	31	Z						

Adopted BASE47 code for lot number				
Decimal	Base47	Decimal	Base47	
value	code	value	code	
0	0	24	R	
1	1	25	S	
2	2	26	Т	
3	3	27	U	
4	4	28	V	
5	5	29	W	
6	6	30	X	
7	7	31	Y	
8	8	32	Z	
9	9	33	b	
10	Α	34	d	
11	В	35	f	
12	С	36	h	
13	D	37	n	
14	E	38	r	
15	F	39	t	
16	G	40	V	
17	Н	41	\	
18	J	42	?	
19	K	43	{	
20	L	44	}	
21	M	45	<	
22	N	46	>	
23	Р			

Table 2: Lists for encoding and decoding of marking.



SAW components	B8048
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13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

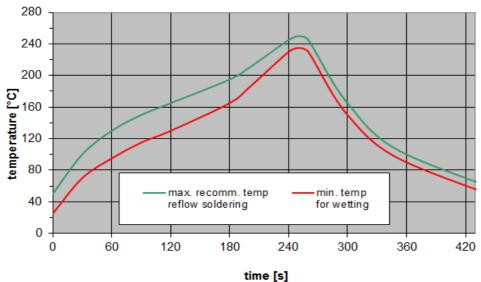


Figure 18: Recommended reflow profile for convection and infrared soldering – lead-free solder.



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14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39941B8048P810	5000 pcs

Table 4: Ordering codes and packing units.



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15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.
 - The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

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